

## N- and P-Channel 60V (D-S) Power MOSFET

### FEATURES

- Low  $R_{DS(ON)}$  to minimize conductive losses
- Low gate charge for fast power switching
- 100% UIS and  $R_g$  tested
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

### APPLICATIONS

- DC-DC Converters
- Power Routing
- Motor Drives

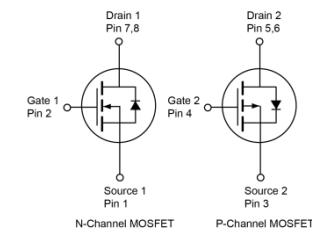
KEY PERFORMANCE PARAMETERS			
PARAMETER	TYPE	VALUE	UNIT
$V_{DS}$	N-ch	60	V
	P-ch	-60	
$R_{DS(on)}$ (max)	$V_{GS} = 10V$	34	mΩ
	$V_{GS} = 4.5V$	40	
	$V_{GS} = -10V$	68	mΩ
	$V_{GS} = -4.5V$	110	
$Q_g$	N-ch	10.3	nC
	P-ch	9.5	



✓  
RoHS  
COMPLIANT

HALOGEN  
FREE

**PDFN56 Dual**



**Note:** MSL 1 (Moisture Sensitivity Level) per J-STD-020

### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	N-ch	P-ch	UNIT
Drain-Source Voltage	$V_{DS}$	60	-60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	$\pm 20$	V
Continuous Drain Current <sup>(Note 1)</sup>	$I_D$	24	-18	A
$T_C = 25^\circ\text{C}$		5.4	-4	
Pulsed Drain Current	$I_{DM}$	96	-72	A
Single Pulse Avalanche Current <sup>(Note 2)</sup>	$I_{AS}$	12.7	-12.7	A
Single Pulse Avalanche Energy <sup>(Note 2)</sup>	$E_{AS}$	24	24	mJ
Total Power Dissipation	$P_D$	40	40	W
$T_C = 125^\circ\text{C}$		8.1	8.1	
Total Power Dissipation	$P_D$	2	2	W
$T_A = 25^\circ\text{C}$		0.4	0.4	
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150		°C

### THERMAL PERFORMANCE

PARAMETER	SYMBOL	LIMIT	UNIT
Thermal Resistance – Junction to Case	$R_{EJC}$	3.1	°C/W
Thermal Resistance – Junction to Ambient	$R_{EJA}$	61	

**Thermal Performance Note:**  $R_{EJA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins.  $R_{EJA}$  is guaranteed by design while  $R_{ECA}$  is determined by the user's board design.

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)								
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYPE</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>	
<b>Static</b>								
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	$BV_{DSS}$	N-ch	60	--	--	V	
	$V_{GS} = 0V, I_D = -250\mu\text{A}$		P-ch	-60	--	--		
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	$V_{GS(\text{TH})}$	N-ch	1.2	1.7	2.5	V	
	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$		P-ch	-1.2	-1.5	-2.5		
Gate-Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	$I_{GSS}$	N-ch	--	--	$\pm 100$	nA	
	$V_{GS} = \pm 20V, V_{DS} = 0V$		P-ch	--	--	$\pm 100$	nA	
Drain-Source Leakage Current	$V_{GS} = 0V, V_{DS} = 60V$	$I_{DSS}$	N-ch	--	--	1	$\mu\text{A}$	
	$V_{GS} = 0V, V_{DS} = 60V$			--	--	100		
	$T_J = 125^\circ\text{C}$		P-ch	--	--	-1		
	$V_{GS} = 0V, V_{DS} = -60V$			--	--	-100		
	$V_{GS} = 0V, V_{DS} = -60V$		P-ch	--	--	$125^\circ\text{C}$		
Drain-Source On-State Resistance <sup>(Note 3)</sup>	$V_{GS} = 10V, I_D = 5.4\text{A}$	$R_{DS(\text{on})}$	N-ch	--	28	34	$\text{m}\Omega$	
	$V_{GS} = 4.5V, I_D = 4.9\text{A}$			--	33	40		
	$V_{GS} = -10V, I_D = -4\text{A}$		P-ch	--	57	68		
	$V_{GS} = -4.5V, I_D = -3.2\text{A}$			--	73	110		
Forward Transconductance <sup>(Note 3)</sup>	$V_{DS} = 5V, I_D = 5.4\text{A}$	$g_{fs}$	N-ch	--	19	--	S	
	$V_{DS} = -5V, I_D = -4\text{A}$		P-ch	--	11	--		
<b>Dynamic</b> <sup>(Note 4)</sup>								
Total Gate Charge	N-ch $V_{DS} = 30V, I_D = 5.4\text{A}$ P-ch $V_{DS} = -30V, I_D = -4\text{A}$	$Q_{g(VGS=10V)}$	N-ch	--	20.8	--	$\text{nC}$	
		$Q_{g(VGS=-10V)}$	P-ch	--	18.1	--		
Total Gate Charge	N-ch $V_{DS} = 30V, I_D = 4.9\text{A}$ P-ch $V_{DS} = -30V, I_D = -3.2\text{A}$	$Q_{g(VGS=4.5V)}$	N-ch	--	10.3	--		
Gate-Source Charge		$Q_{g(VGS=4.5V)}$	P-ch	--	9.5	--		
Gate-Drain Charge		$Q_{gs}$	N-ch	--	3.9	--		
			P-ch	--	2.6	--		
Input Capacitance	N-ch $V_{GS} = 0V, V_{DS} = 30V$ $f = 1.0\text{MHz}$ P-ch	$Q_{gd}$	N-ch	--	4.2	--		
			P-ch	--	4.8	--		
Output Capacitance		$C_{iss}$	N-ch	--	1159	--	$\text{pF}$	
			P-ch	--	930	--		
Reverse Transfer Capacitance	$V_{GS} = 0V, V_{DS} = -30V$ $f = 1.0\text{MHz}$	$C_{oss}$	N-ch	--	59	--		
			P-ch	--	65	--		
Gate Resistance		$C_{rss}$	N-ch	--	15	--	$\Omega$	
			P-ch	--	26	--		
		$R_g$	N-ch	0.6	2	4	$\Omega$	
			P-ch	4.5	15	30		

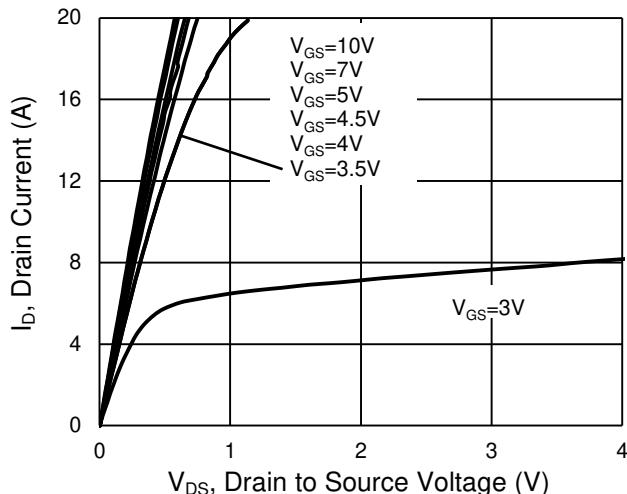
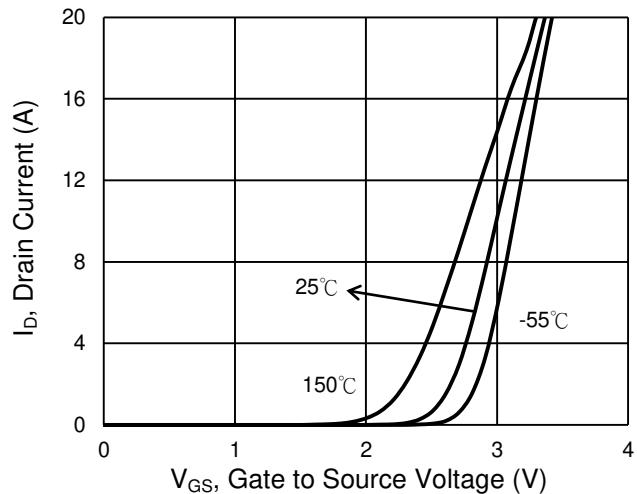
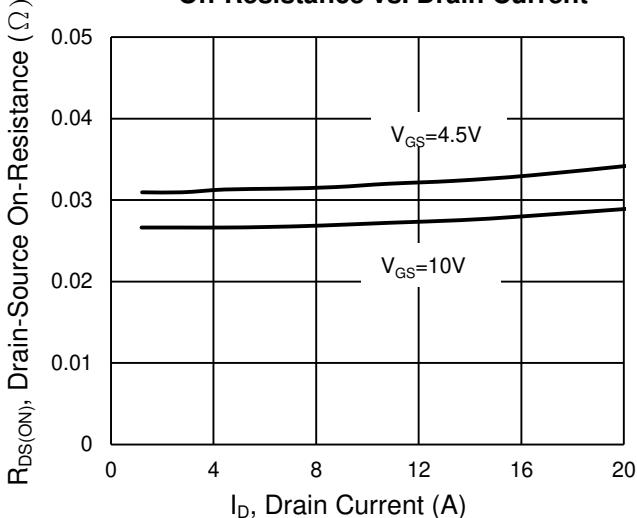
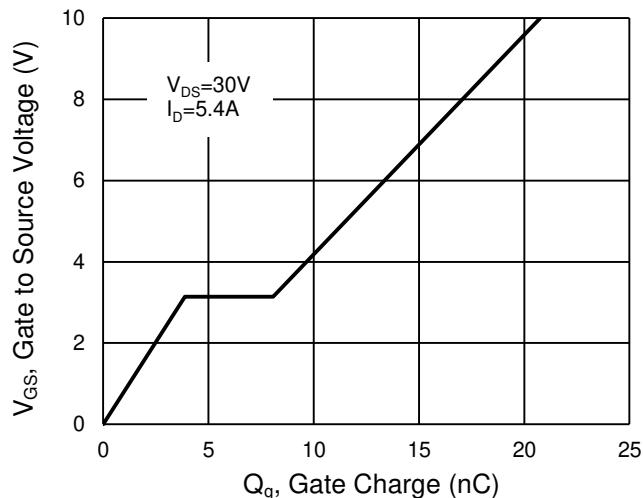
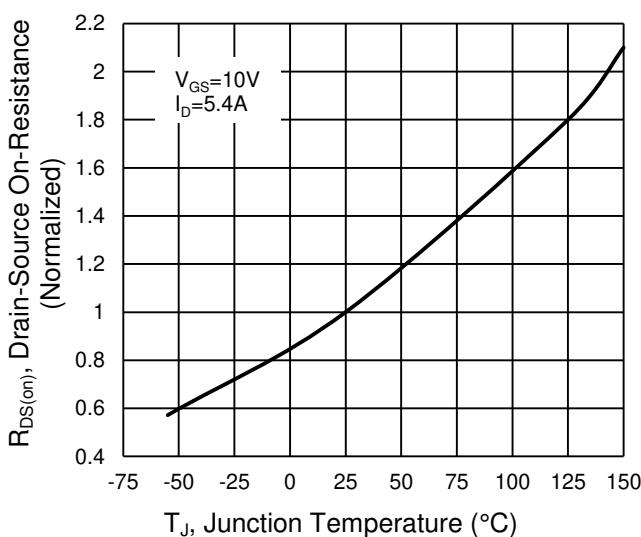
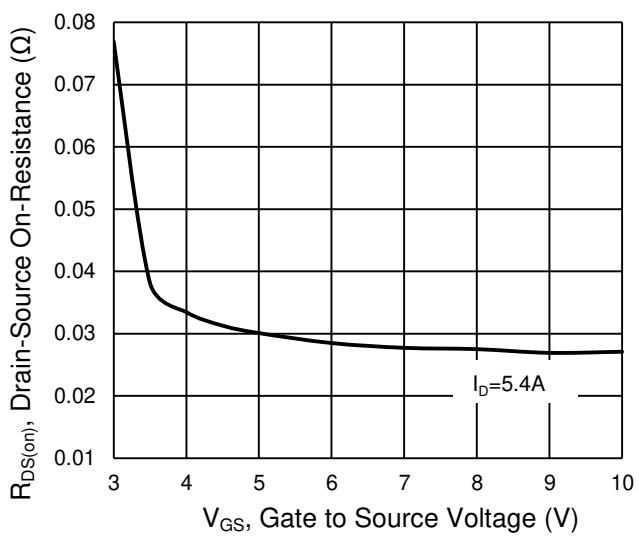
<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)							
<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYPE</b>	<b>MIN</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
<b>Switching</b> <small>(Note 4)</small>							
Turn-On Delay Time	N-ch $V_{GS} = 10V, V_{DS} = 30V, I_D = 5.4A, R_G = 2\Omega$	$t_{d(on)}$	N-ch	--	7.4	--	ns
			P-ch	--	4	--	
Turn-On Rise Time	P-ch $V_{GS} = -10V, V_{DS} = -30V, I_D = -4A, R_G = 2\Omega$	$t_r$	N-ch	--	25	--	
			P-ch	--	28	--	
	N-ch $V_{GS} = 0V, I_S = 5.4A$	$t_{d(off)}$	N-ch	--	18	--	
			P-ch	--	44	--	
Turn-Off Fall Time	P-ch $I_S = -4A, R_G = 2\Omega$	$t_f$	N-ch	--	18	--	
			P-ch	--	44	--	
<b>Source-Drain Diode</b>							
Forward Voltage <small>(Note 3)</small>	$V_{GS} = 0V, I_S = 5.4A$	$V_{SD}$	N-ch	--	--	1	V
			P-ch	--	--	-1	
Reverse Recovery Time	N-ch $I_S = 5.4A, dI/dt = 100A/\mu\text{s}$	$t_{rr}$	N-ch	--	16	--	ns
			P-ch	--	13	--	
	P-ch $I_S = -4A, dI/dt = 100A/\mu\text{s}$	$Q_{rr}$	N-ch	--	11	--	nC
			P-ch	--	7.8	--	

**Notes:**

1. Silicon limited current only.
2. N-ch :  $L = 0.3mH, V_{GS} = 10V, V_{DD} = 25V, R_G = 25\Omega, I_{AS} = 12.7A$ , Starting  $T_J = 25^\circ\text{C}$   
P-ch :  $L = 0.3mH, V_{GS} = -10V, V_{DD} = -25V, R_G = 25\Omega, I_{AS} = -12.7A$ , Starting  $T_J = 25^\circ\text{C}$
3. Pulse test: Pulse Width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
4. Switching time is essentially independent of operating temperature.

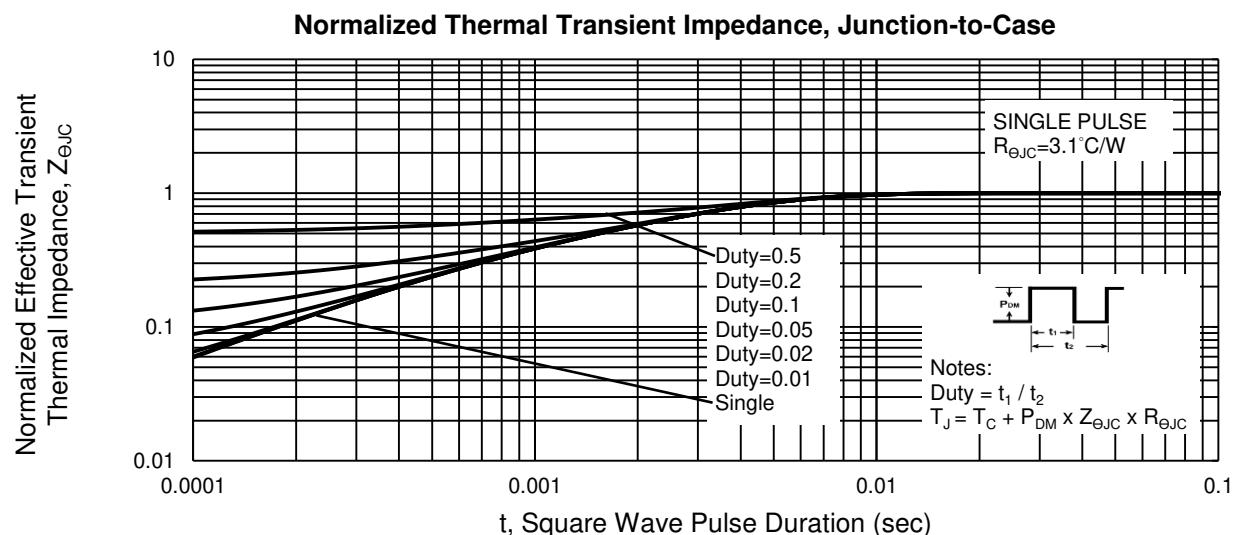
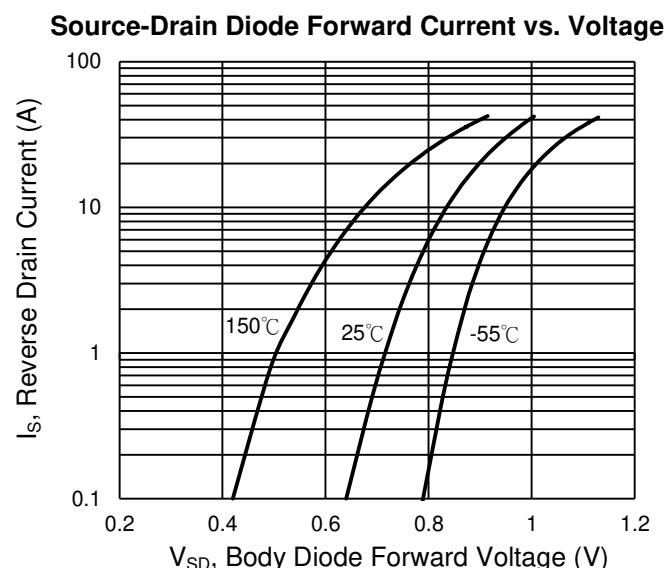
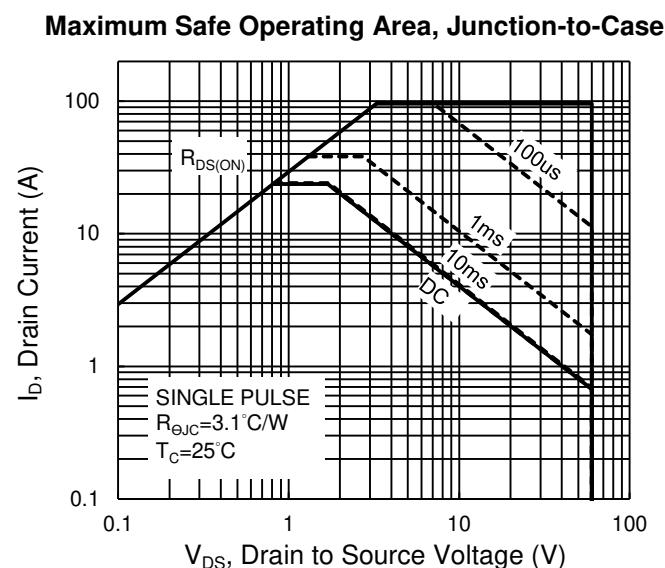
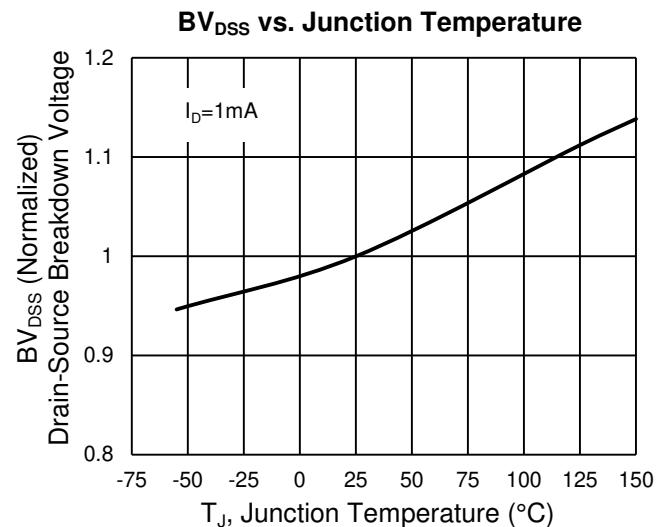
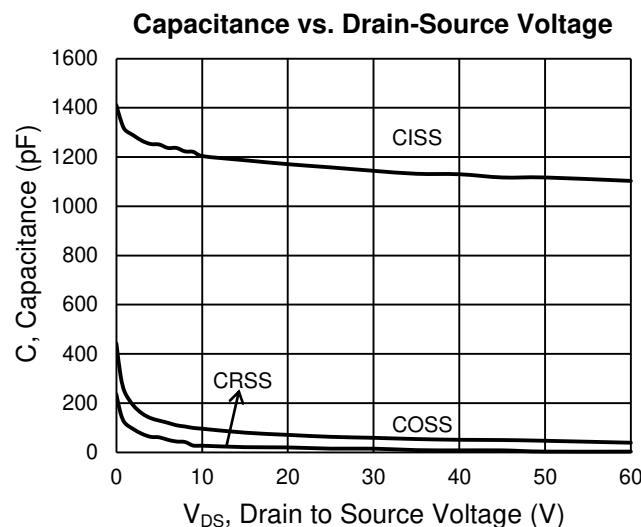
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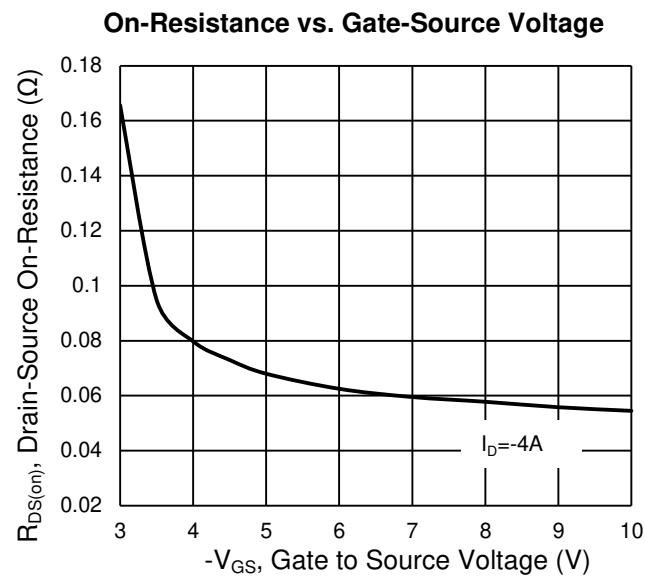
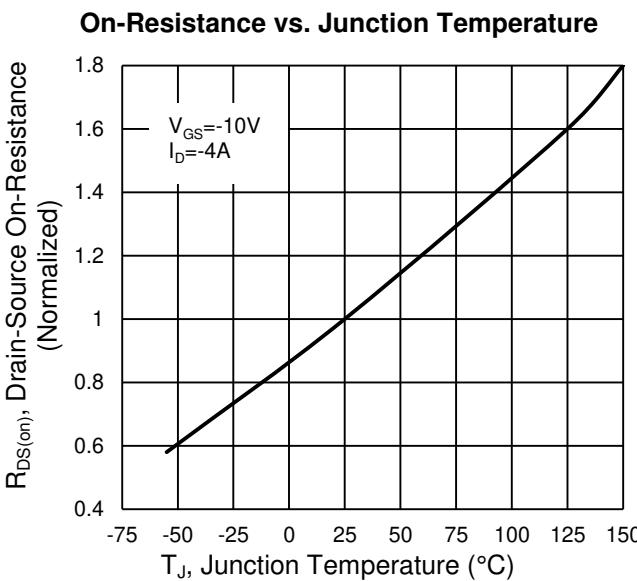
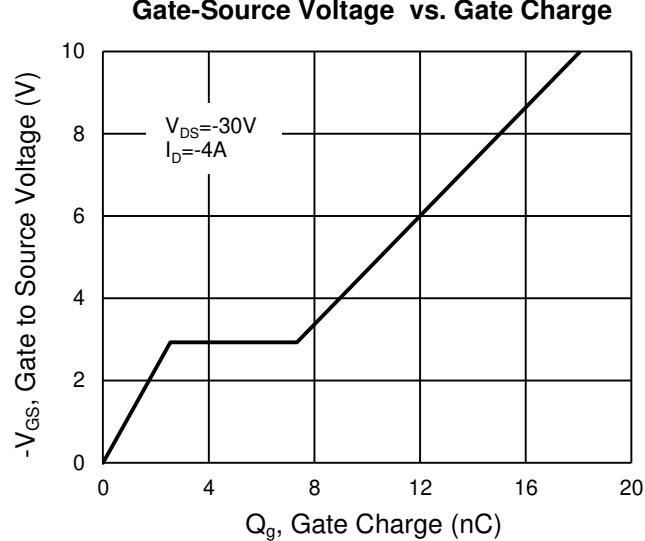
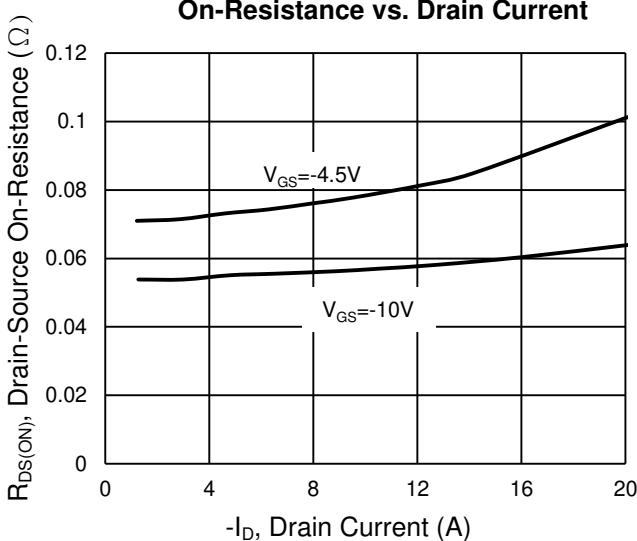
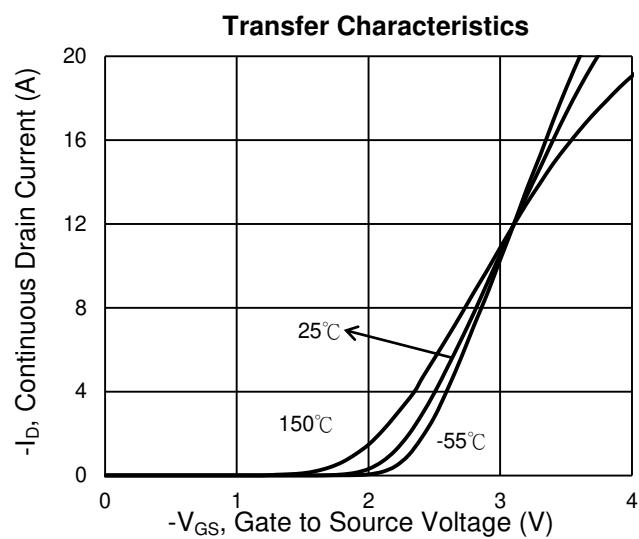
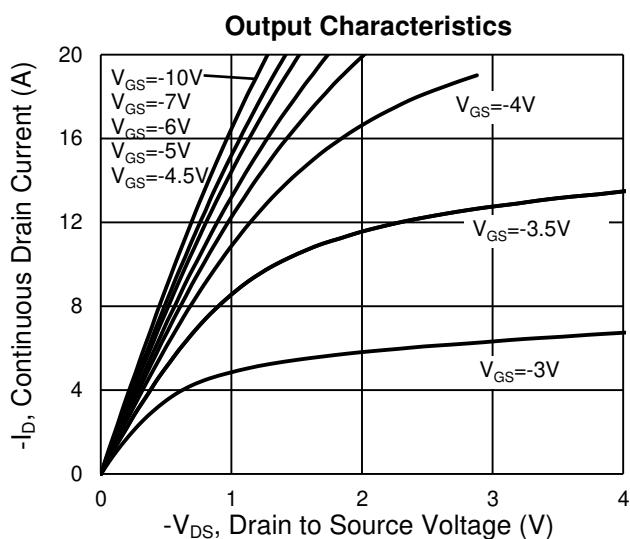
<b>PART NO.</b>	<b>PACKAGE</b>	<b>PACKING</b>
TSM6502CR RLG	PDFN56 Dual	2,500pcs / 13" Reel

**CHARACTERISTICS CURVES (N-Channel)**
 $(T_A = 25^\circ\text{C} \text{ unless otherwise noted})$ 
**Output Characteristics**

**Transfer Characteristics**

**On-Resistance vs. Drain Current**

**Gate-Source Voltage vs. Gate Charge**

**On-Resistance vs. Junction Temperature**

**On-Resistance vs. Gate-Source Voltage**


## CHARACTERISTICS CURVES (N-Channel)

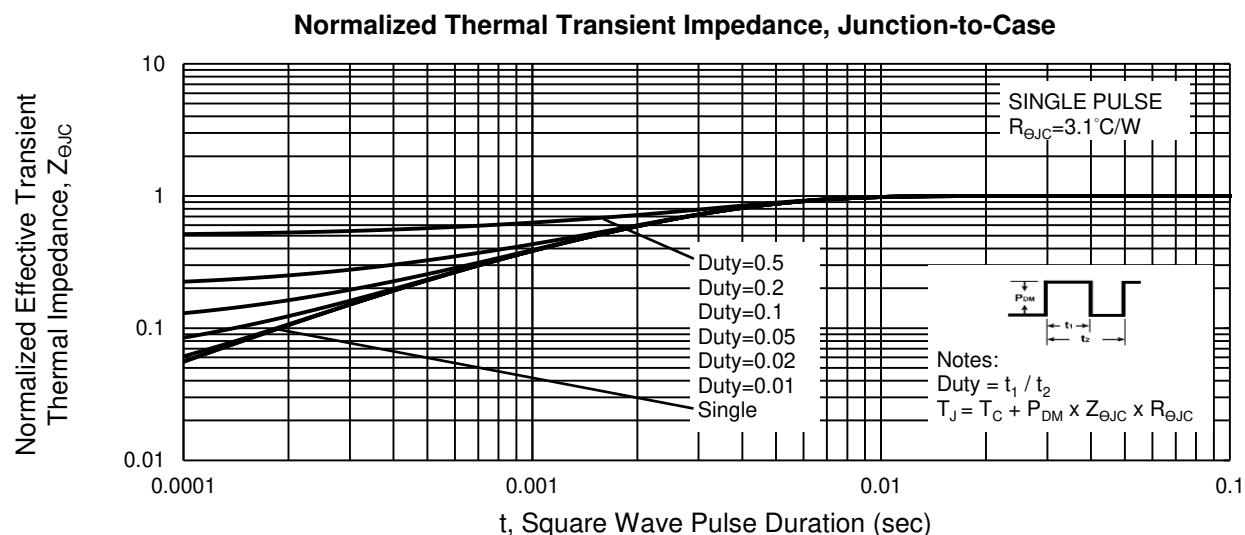
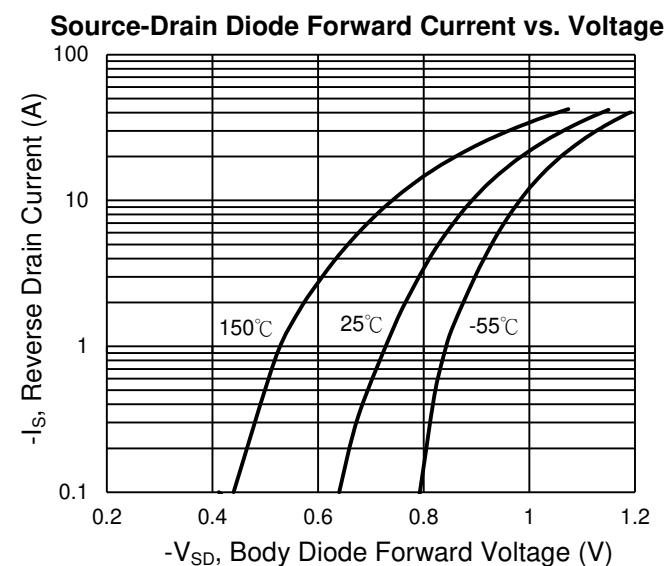
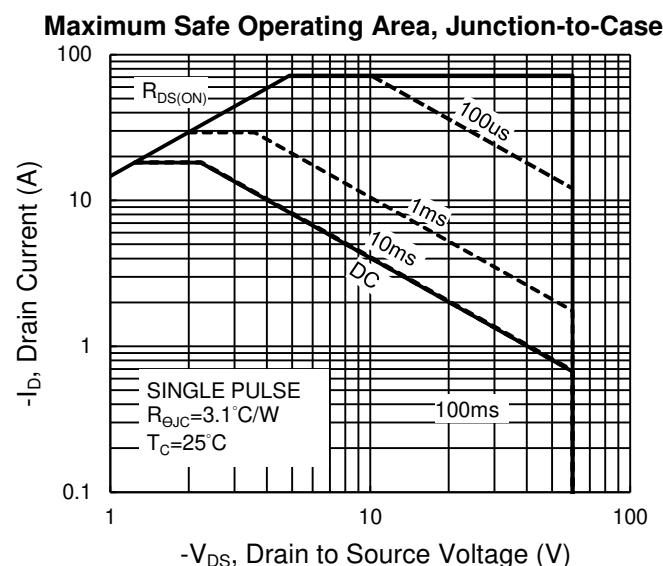
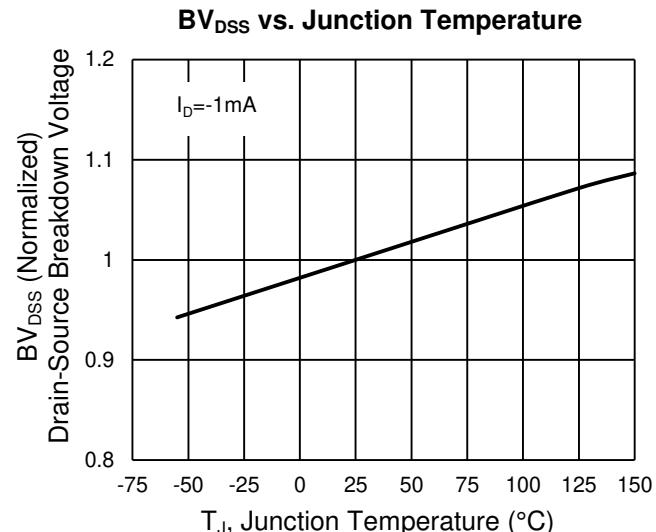
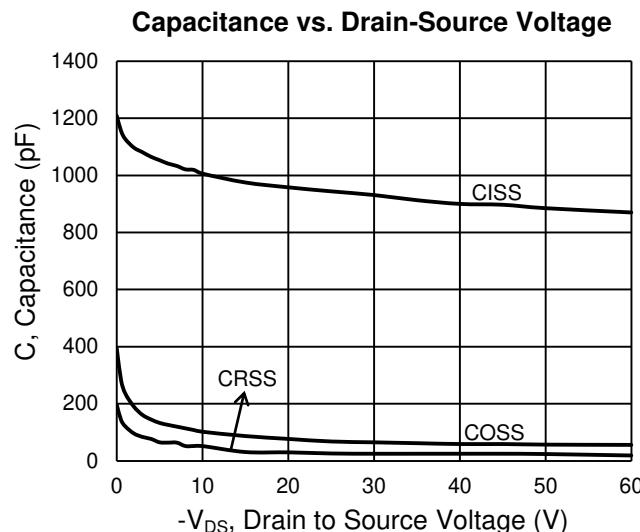
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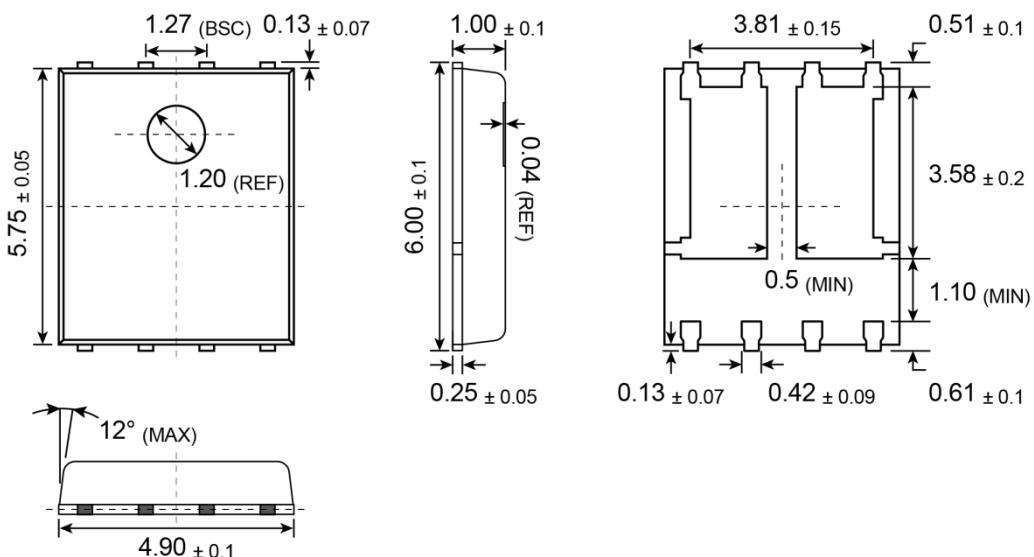
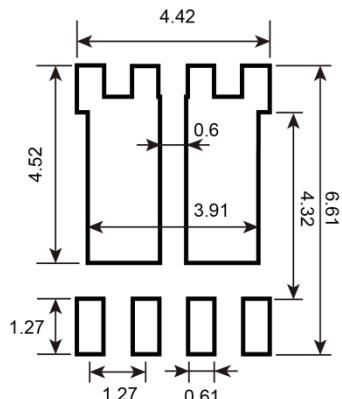
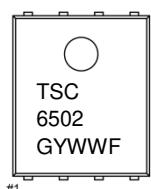
**CHARACTERISTICS CURVES (P-Channel)**
 $(T_A = 25^\circ\text{C} \text{ unless otherwise noted})$ 


## CHARACTERISTICS CURVES (P-Channel)

( $T_A = 25^\circ\text{C}$  unless otherwise noted)



**PACKAGE OUTLINE DIMENSIONS** (Unit: Millimeters)

**PDFN56 Dual**

**SUGGESTED PAD LAYOUT** (Unit: Millimeters)

**MARKING DIAGRAM**


- G** = Halogen Free
- Y** = Year Code
- WW** = Week Code (01~52)
- F** = Factory Code

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